

Customer Product Information (CPI)

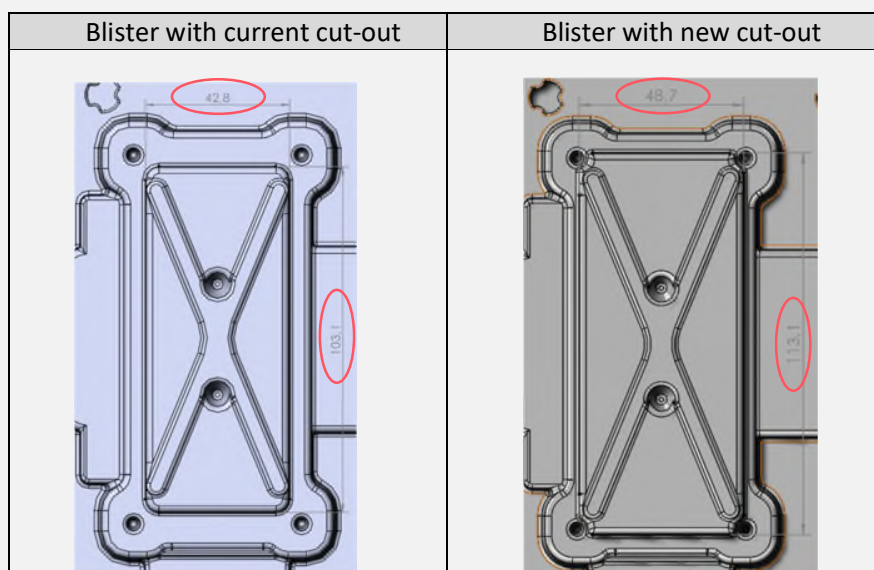
Product group:	SEMIX	Rev.:	0
No.:	PN24-057	SEMIX13, SEMIX13D/T packaging blister optimization	13.05.2024

Dear valued partner,
Thank you for using Semikron Danfoss products. Within our continuous improvement activities we are working to enhance performance, quality and reliability of our products. This notification is to inform you of a minor change, where no acknowledgment is required.

Subject of change: SEMIX13, SEMIX13D/T packaging blister optimization

**SEMIKRON
product type:** Packaging blister

**Description
of change:** The SEMIX13 packaging blister is used as product packaging for both with Thermal Interface Material (TIM) pre-applied and non pre-applied modules. As the cut-out for pre-applied modules is too small to fully protect the TIM pattern against damage, it must be enlarged as shown below.



Reason for change: Better protection of the TIM print

Impact of change: Change of cut-out dimension. No change of total dimensions of the packaging blister.

Identification of change: Cut-out dimension

Time schedule for change: From June onwards

Qualification: n.a.

Supporting documentation: n.a.

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Products Affected:

The following table shows the affected products:

Part. No.	Description
27891200	SEMiX101GD066HDs
27890730	SEMiX101GD126HDs
27890195	SEMiX101GD12E4s
27890195V	SEMiX101GD12E4s Variant
27891210	SEMiX151GD066HDs
27890731	SEMiX151GD126HDs
27890200	SEMiX151GD12E4s
27890201	SEMiX151GD12Vs
27891220	SEMiX201GD066HDs
27890732	SEMiX251GD126HDs
27890190	SEMiX71GD12E4s
27890840	SEMiX241DH16s
27890840V	SEMiX241DH16s Variant
27890180	SEMiX251D12Fs
27890816	SEMiX291D16s
27890816V	SEMiX291D16s Variant
27890830	SEMiX341D16s
27890830V	SEMiX341D16s Variant
27891400	SEMiX501D17Fs
27891400V	SEMiX501D17Fs Variant